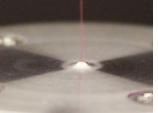


JADE MKIV

Enhanced, entry-level, single point selective soldering system

















)JADE MKIV

Enhanced, entry-level, single point selective soldering system



Designed to meet the needs of the small batch manufacturer who requires a high level of production flexibility, the Jade MKIV offers uncompromised selective soldering quality at a very low cost.

The Jade MKIV is a handload system, incorporating a universally adjustable tooling carrier capable of accommodating PCB's or pallets up to $508mm \times 610mm (20" \times 24")$.

Our patented Drop-Jet design fluxer offers quick and effective flushing of the pressurised flux chamber. This helps to keep maintenance levels to a minimum whilst enabling use of higher solid content fluxes as well as water-soluble fluxes.

As part of the entry-level philosophy for this system, a low maintenance solder bath and pump mechanism has been developed which moves in three axes of movement whilst not limiting access to the PCB. Solder is applied using proven technology through our AP nozzle design or custom specialised nozzles.

As with all Pillarhouse systems, the soldering process is enhanced by a hot nitrogen curtain which provides an inert atmosphere. This method of soldering also assists in the prevention of oxidisation and provides a local pre-heat to the joint, thus reducing thermal shock to localised components.



DROP-JET



ULTRASONIC FLUX HEAD

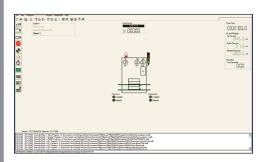


AP SOLDER NOZZLE





SLIDE IN/OUT BOTTOM SIDE I.R. PRE-HEAT



OPERATION

The Jade MKIV is controlled by a PC through our next generation PillarCOMMX software - a Windows® based 'Point & Click' interface with PCB image display, as illustrated above.

Additionally, our optional PillarPAD offline package allows the operator to produce programs independently from the machine using Gerber data.



HIGH RESOLUTION
PROCESS VIEWING CAMERA



STANDARD FEATURES

Integral PC & Machine Mounted TFT Monitor

Inerted Nitrogen System

Auto Motorised Solder Wire Feed & Level Detect

Drop-Jet Fluxer

Internal Fume Extraction

Colour Programming Camera

Universally Adjustable Tooling Carriers

Manual Fiducial Correction System

PillarCOMMX Windows® Software

PillarPAD Offline Programming System

New Rapid Change Solder Bath and Pump Design

Pump RPM Monitoring (applicable to mechanical pump only)

Thermal Nozzle Calibration System using Integrated Setting Camera (requires manual correction)

Solder Wave Height Measurement

Process Viewing Camera

Multilevel Password Protection System

Lead-Free Compatibility

Set of AP Style Solder Nozzle Tips

Accessory Kit

MONITORING OPTIONS

Flux Presence Sensor - Thermistor Style

Flux Spray and/or Flow

O₂ PPM

Nitrogen Flow

Nozzle Nitrogen Purity

SYSTEM OPTIONS

Ultrasonic Fluxing

Dual Drop-Jet/Ultrasonic Fluxing

Top Side Instant IR Pre-Heat

Bottom Side Slide In/Out IR Pre-Heat

Closed-Loop Pyrometer Temperature Control

Solder Reel Identification

Solder Bath Coding (identifies correct bath for program)

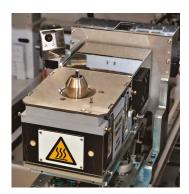
Automatic Fiducial Correction System

Laser PCB Warp Correction





AUTOMATIC NOZZLE
CONDITIONING SYSTEM



NEXT GENERATION SOLDER
BATH AND PUMP



ADDITIONAL SYSTEM OPTION - PillarCARE Pillarhouse's comprehensive after-sale service and process programme, available for all machines



JADE MKIV

SPECIFICATIONS

Flux:

2011mm/79" - including light stack Height:

Width: 1110mm/43" Depth: 2061mm / 81"

Board size: Max. - 508mm x 610mm/20"x 24"

Above/below 3mm Edge clearance:

Above 95mm/below 45mm nominal Height clearance:

Most commonly used solder types - includes lead-free Solder:

Solder pot capacity: 10kg / 22lb

AP style - 2.5mm to 16mm dia. Applicators:

Extended AP style - 2.5mm to 20mm dia.

Micro Nozzle - 1.5mm to 2.5mm Jet-tip style - 6mm to 40mm dia. Jet-Wave nozzle - up to 25mm width

Special dedicated nozzles available upon request Low maintenance Drop-Jet system. Low solids (below

8%), no clean flux, pressurised and inerted system,

optional water-soluble system available.

X, Y & Z axis resolution: 0.15mm Repeatability: +/- 0.05mm. Nitrogen supply pressure: 5 bar/72 psi

30-100 litres/min./1.06-3.53 CFM- solder nozzle Nitrogen usage:

configuration dependent

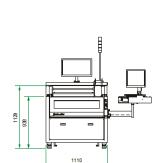
99.995% or better Nitrogen purity:

Air supply pressure: 5 bar/72 psi

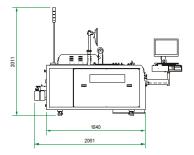
10 litres/min./0.35 CFM Air usage: Power Supplies: Single phase + PE

230V Voltage: Frequency: 50/60Hz

Power: 14.5 kVA max. - machine configuration dependent Programming: PillarCOMMX Windows® based 'Point & Click' interface



INTERNATIONAL



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